ATROX® 800HT2VX

Silver Sintered Electrically and Highly Thermally Conductive Die Attach Paste

DESCRIPTION

ATROX 800HT2VX is a silver sintered electrically and highly thermally conductive die attach paste with very high thermal conductivity designed for high-power semiconductor packages. **ATROX 800HT2VX** has low resin bleed-out and low condensable organics which ensure excellent package reliability.

READ ENTIRE TECHNICAL DATA SHEET BEFORE USING THIS PRODUCT

TYPICAL PROPERTIES

Material Properties	Method	Value	Remarks
A. Uncured			
Chemical Type		Thermosetting	
Color	Visual	Grey	
Viscosity at 25 °C at 5.0 RPM	ASTM D2196-99	58,000 CPs	Brookfield Spindle 51
Thixotropic index (0.5 RPM/5.0 RPM)	ASTM D2196-99	5.0	Brookfield Spindle 51
Pot Life @ 23 °C (elapsed time for 25% increase in viscosity)	ISO 10364:1993	>24 hours	Brookfield Spindle 51
Storage Temperature		-40 °C	
Shelf Life @ -40 (°C/°F)		6 months	
B. Cured			
Glass Transition (Tan δ Max)	DMA	53.5 °C	
Modulus at 25 °C	DMA	11.7 GPa	
Modulus at 260 °C	DMA	2.7 GPa	

Material Properties	Method	Value	Remarks
CTE 1 (below Tg)	TMA	37 ppm	
CTE 2 (above Tg)	TMA	102 ppm	
Thermal Conductivity: Bulk	Laser Flash	>175 W/mK	
Volume Resistivity	4-Point Probe	0.000014 Ohms-cm	

DIE SHEAR STRENGTH (1 mm x 5 mm)

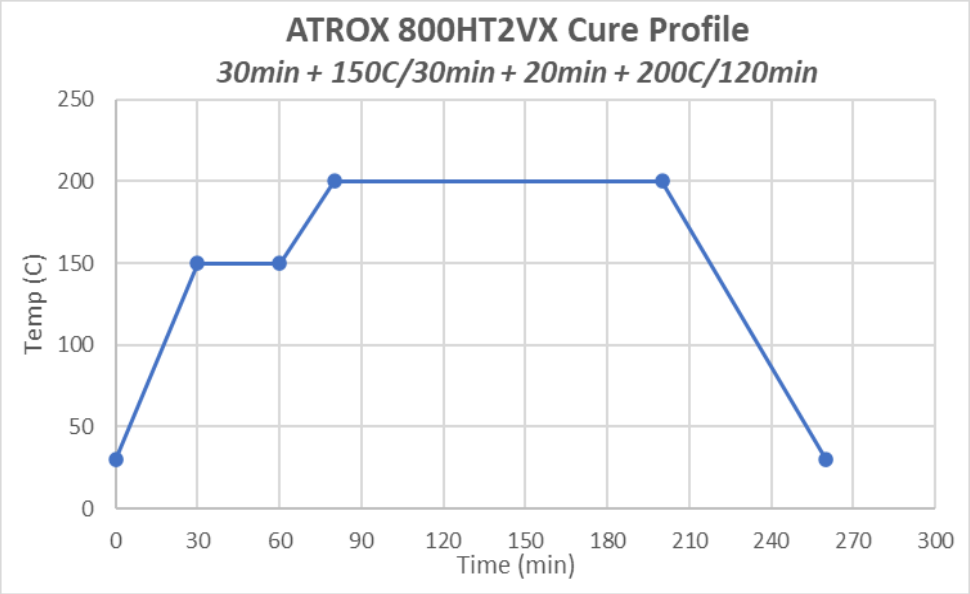
Lead Frame	Cure Condition	Shear Temperature	Value
A. Metallized Die			
Ag	RT to 150 °C/30 min + 200 °C/120 min	260 °C	13 Kg-F
PPF (NiPdAu)	RT to 150 °C/30 min + 200 °C/120 min	260 °C	14 Kg-F
Cu	RT to 150 °C/30 min + 200 °C/120 min	260 °C	15 Kg-F

MATERIAL APPLICATION

ATROX 800HT2VX is formulated to be applied using a time pressure pump equipped on most die bonders. The material should be consistently dispensed over time. Equipment settings need to be optimized for desired material deposition response based on model and configuration.

CURE

ATROX 800HT2VX cures using ramp profile with 30 minute soak at 150 °C + ramp 20 minutes to 200 °C and soak for 120 minutes. For enhanced sintering, a 250 °C peak temperature can be employed with similar ramp rates. It is recommended that the cure schedule includes a ramp at 5 to 10 °C and a controlled cooling cycle to minimize thermal stresses. Depending on the thermal mass of the application cure times may vary and should be optimized by the end user.



RELIABILITY PERFORMANCE

ATROX 800HT2VX is recommended for excellent reliability with stable Electrical and Thermal performance during MSL and Thermal Cycling. There is no limitation on die size for metalized die packages. However, it is recommended to consult with your local Technical Service for optimizing critical parameters for specific packages.

It is also possible to assemble Bare Silicon dies up to 10 mm^2 with excellent Electrical and Thermal performance. For die sizes larger than 10 mm^2, contact MacDermid Alpha for assistance.

CLEAN-UP

Uncured material may be cleaned from dispenser components and surfaces with a variety of solvents, including IPA, acetone, MEK, methylene chloride, etc. Always wash and dry thoroughly prior to re-use of the dispenser components. The cleaning technique should be active cleaning of the components – flush, wash or wipe, followed by a drying step to ensure a clean, dry surface. Do not soak since this can solubilize the hardener within the uncured resin and curing (very difficult to remove). Contact your equipment supplier to ensure the solvent is compatible with their components. Clean and maintain dispense valves as recommended by the equipment manufacturer.

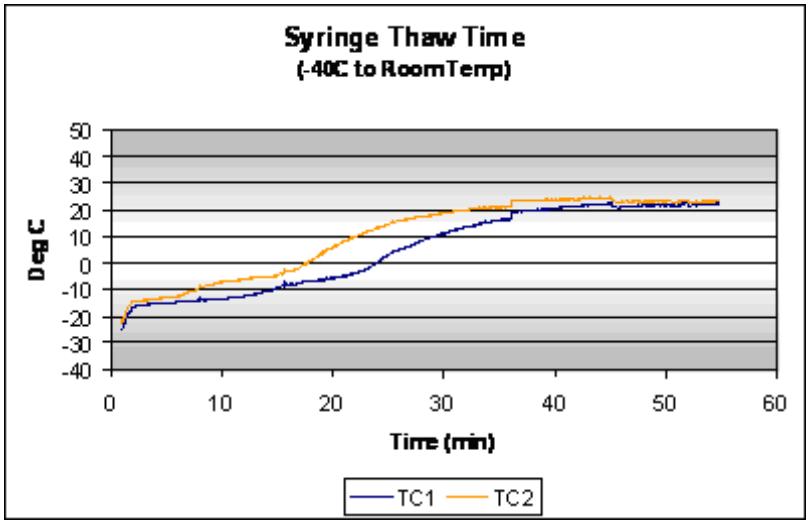
AVAILABILITY

ATROX 800HT2VX is available in 5 or 10 cc EFD or Musashi syringes and 100 g jars.

SHIPPING & STORAGE

Material is normally shipped in insulated boxes using dry ice to ensure that the ATROX 800HT2VX maintains all its properties. On receipt, it must be ensured that dry-ice remnants are present in the insulated shipping box. If there is no dry ice, or if the material is not cold, then please contact Alpha Advanced Materials immediately. Exposure to elevated temperatures during shipment and storage will compromise the performance aspect of the material adversely.

It is recommended to store the syringes of material at -40 °C for a maximum shelf life of 6 months. It is recommended that the material be allowed to thaw before usage. Typical thawing times for 5cc and 10cc syringes are presented in the chart below. Remove the syringe from the freezer and set it aside, allowing it to thaw at room temperature, until it reaches room temperature (90 minutes maximum for 30cc syringe). To prevent contamination of unused products, do not return any material to its original container.



SAFETY & WARNING

It is recommended that the company/operator read and review the Safety Data Sheets for the appropriate health and safety warnings before use. **Safety Data Sheets are available.**

CONTACT INFORMATION

To confirm this document is the most recent version, please contact
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www.macdermidalpha.com

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Also read carefully warning and safety information on the Safety Data Sheet. This data sheet contains technical information required for safe and economical operation of this product. READ IT THOROUGHLY PRIOR TO PRODUCT USE . Emergency safety directory assistance: US 1 202 464 2554, Europe + 44 1235 239 670, Asia + 65 3158 1074, Brazil 0800 707 7022 and 0800 172 020, Mexico 01800 002 1400 and (55) 5559 1588